

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT5931351

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
VENKATESHWAR R. AITHARAJU	01/27/2020
WILLIAM R. RODGERS	01/27/2020
SELINA X. ZHAO	01/27/2020
TERRENCE WATHEN	01/27/2020
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	GM GLOBAL TECHNOLOGY OPERATIONS LLC
<b>Street Address:</b>	P.O. BOX 300
<b>Internal Address:</b>	MAIL CODE 482-C22-A68
<b>City:</b>	DETROIT
<b>State/Country:</b>	MICHIGAN
<b>Postal Code:</b>	48265-3000
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	16773516
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(248)641-0270
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	(248)641-1600
<b>Email:</b>	mailroom@HDP.com, pmorrow@hdp.com
<b>Correspondent Name:</b>	HARNESS, DICKEY & PIERCE P.L.C. (GM)
<b>Address Line 1:</b>	5445 CORPORATE DRIVE
<b>Address Line 2:</b>	SUITE 200
<b>Address Line 4:</b>	TROY, MICHIGAN 48098
<b>ATTORNEY DOCKET NUMBER:</b>	P051485-US-NP
<b>NAME OF SUBMITTER:</b>	PARISH N. MORROW
<b>SIGNATURE:</b>	/Parish N. Morrow/
<b>DATE SIGNED:</b>	01/27/2020
<b>Total Attachments: 1</b>	



**ASSIGNMENT**

Pursuant to an agreement with my employer, I formally assign to GM GLOBAL TECHNOLOGY OPERATIONS LLC, the entire right, title and interest, in all countries and application types, in the improvements set forth in the United States patent application P051485-US-NP entitled

**COMPOSITE COMPONENTS AND METHODS OF MANUFACTURING COMPOSITE COMPONENTS USING MAGNETIC FORCES AT FIBER PREFORM SEAMS**

for which I executed a declaration. If the patent application has been filed, I authorize any practitioner associated with Customer No. 74175 to insert the application number and filing date of said application here in parentheses ( 16/773,516 filed January 27, 2020 ) when known.

Inventor's signature A Venkateshwar R Date 1/27/2020

Full name : Venkateshwar R. Aitharaju

Residence : TROY, MICHIGAN

Inventor's signature William R Rodgers Date 1/27/2020

Full name : William R. Rodgers

Residence : BLOOMFIELD TOWNSHIP, MICHIGAN

Inventor's signature Selina X. Zhao Date 01/27/2020

Full name : Selina X. Zhao

Residence : ROCHESTER HILLS, MICHIGAN

Inventor's signature Terrence J Wathen Date 27 Jan 2020

Full name : Terrence Wathen

Residence : STERLING HEIGHTS, MICHIGAN